PAPER   *Special Section on Analog Circuit Techniques and Related Topics*

Threshold-Logic Devices Consisting of Subthreshold CMOS Circuits

Taichi OGAWA[†a]**,** *Student Member,* **Tetsuya HIROSE**[††]**, Tetsuya ASAI**[†]**,** *and* **Yoshihito AMEMIYA**[†]**,** *Members*

SUMMARY   A threshold-logic gate device consisting of subthreshold MOSFET circuits is proposed. The gate device performs threshold-logic operation, using the technique of current-mode addition and subtraction. Sample digital subsystems, i.e., adders and morphological operation cells based on threshold logic, are designed using the gate devices, and their operations are confirmed by computer simulation. The device has a simple structure and operates at low power dissipation, so it is suitable for constructing cell-based, parallel processing LSIs such as cellular-automaton and neural-network LSIs.
key words: *subthreshold, MOS, circuit, threshold logic, majority logic, gate, current mode*

1. Introduction

Threshold logic is a way of digital processing that is more functional than conventional AND-OR Boolean logic. To construct LSIs based on threshold logic, we propose a gate device for threshold-logic operation that is compatible with silicon technology. This device is a threshold logic gate consisting of subthreshold-operated MOSFET circuits.

   Threshold logic implements digital operations in a manner different from that of Boolean logic. Instead of using Boolean logic operators (AND, OR, and their complements), threshold logic represents and manipulates digital functions on the basis of threshold comparison. The logic process of threshold logic is much more sophisticated than that of Boolean logic; consequently, threshold logic is more powerful for implementing a given digital function with a smaller number of logic gates. Besides, threshold logic is very compatible with functional processing architectures such as the cellular automaton, neural network, and holonic processing.

   In this paper, we propose a method of constructing gate devices for threshold logic. Section 2 outlines the unit function required for threshold logic and presents a method of implementing the function using the technique of current-mode addition and subtraction. Section 3 presents a gate device that can implement the unit function with CMOS technology. The device consists of a MOSFET circuit operated in the subthreshold region, i.e., the region where the gate-source voltage is smaller than the threshold voltage of MOS-

FETs and drain-source current is in a range of 1–100 nA. The logic operation of the device is studied by computer simulation. Section 4 describes the design of simple subsystems, adders and morphological operation cells consisting of our gate devices. The simulated operation of these subsystems is also described.

2. Implementing the Function of Threshold Logic

2.1 Unit Function of Threshold Logic

The unit function of threshold logic is determining the output logic value on the basis of threshold comparison. The logic element, a threshold-logic gate, has a number of binary inputs and a binary output. It produces an output of 1 if the sum of inputs is larger than a threshold value, and produces an output of 0 if the sum is smaller than the threshold. The function of a five-input gate is shown in Fig. 1 for various values of threshold k. If the threshold is 3.5 for instance, the output is 0 for inputs 1, 1, 0, 0, 1, and the output is 1 for inputs 1, 1, 0, 1, 1. (For further details on threshold logic, see Ref. [1]) Any digital function can be implemented using a combination of threshold gates and inverters. If a gate has odd number n of inputs and the threshold is set to $n/2$, the gate performs the operation of majority logic because its output is determined with majority vote of 1-0 inputs. Three-input majority gates suffice for the construction of any logic functions.

2.2 Implementing the Unit Function

To implement such threshold logic operation, we developed a gate circuit on the basis of a current-mode addition/subtraction technique. The concept of the circuit is illustrated in Fig. 2. The circuit consists of two subcircuits: a threshold current source kI_0, and input current sources I_0 with switches controlled by binary input signals X_i (ith switch is on for $X_i = 1$). The threshold current source drains current kI_0 (k is the threshold of the gate) from the sum line, and each input current source injects current I_0 into the sum line. The net current injected to the sum line is $(\sum X_i - k)I_0$. The circuit accepts 1-0 binary inputs X_i and compares the number of 1-inputs with threshold k to produce the corresponding output voltage. If the number of 1-inputs is larger than k, the net current for the sum-line is positive and, consequently, the voltage of the sum line will rise to a 1 state; otherwise the net current is negative and the voltage of the
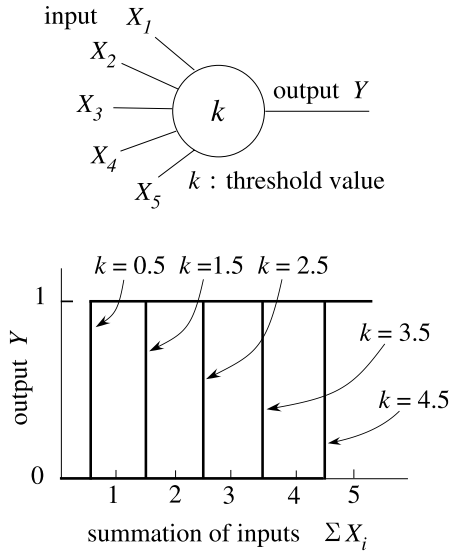
Fig. 1 Symbol for a threshold-logic gate with five inputs and its transfer characteristic for various values of threshold k.
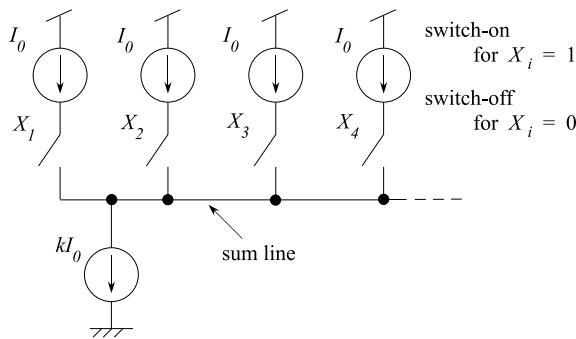

Fig. 2 Threshold logic circuit based on current-made addition and subtraction. Theshold is represented by k.

sum line will fall to a 0 state.

3. Constructing the Threshold-Logic Gate Circuit

3.1 Gate Circuit

The threshold logic gate (M_1-M_6) we propose is illustrated in Fig. 3, with an example of a three-input configuration (a CMOS inverter M_7-M_8 is also shown). It consists of input transistors M_1-M_3 with a gate width of W, threshold-current transistor M_4 with a gate width of $(n - k)W$ (k: threshold value, n: the number of inputs) and an output inverter M_5-M_6. Bias voltages V_{dd} and V_{gg} are set to appropriate values so that, when the input voltage is 0, the current flowing through each of M_1-M_3 will be $1/k$ of the current through M_4. This can be performed using a power supply circuit shown later in Figs. 5 and 6.

The operation of the gate circuit is as follows. If the number of 1-inputs (or inputs with voltage V_{dd}) for M_1-M_3 is smaller than threshold k, the net current injected to the sum line is positive. This raises the voltage of the sum line to a
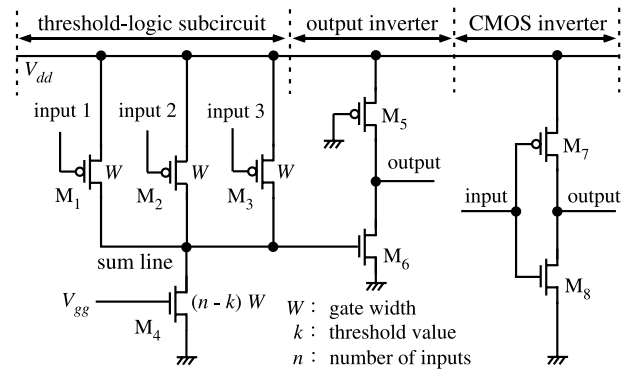

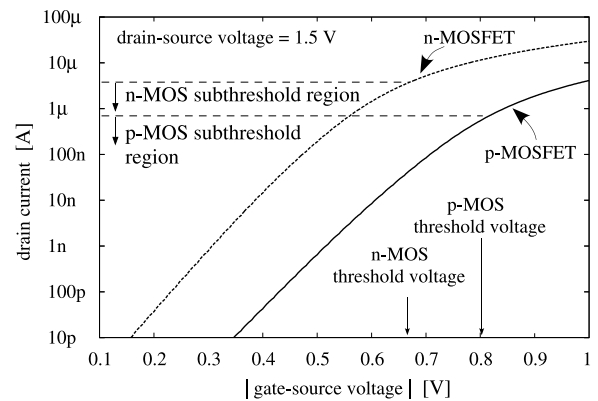**Fig. 3** Threshold-logic gate (M_1-M_6) consisting of CMOS circuit. CMOS inverter (M_7-M_8) is also shown.

Fig. 4 Transfer characteristics of nMOS and pMOS transistors (0.35-μm CMOS devices, $W/L = 1.5\,\mu$m/0.35 μm).

high value, so the output of inverter M_5-M_6 falls to 0 (logic 0). In contrast, if the number of 1-inputs is larger than k, the net current for the sum line is negative; consequently, the voltage of the sum line falls to a low value, and the output of the inverter rises to V_{dd} (logic 1). The gate operates as a majority gate if we set k to 3/2.

Our threshold logic gate uses a current flow for logic operation, thereby producing power dissipation even in a static state; this would be inevitable generally in threshold gate devices and other analog-like logic devices. To reduce power dissipation, we operate the gate circuit in the sub-threshold region of MOSFETs.

The subthreshold region is a region where the gate-source voltage of a MOSFET is smaller than the threshold voltage of the MOSFET (see [2] for details of the subthreshold operation of MOSFETs). Figure 4 shows the transfer characteristics of nMOS and pMOS transistors (0.35-μm CMOS devices, $W/L = 1.5\,\mu$m/0.35 μm) we used to design the gate circuit. In this example, a region where current is smaller than 1–2 μA is the subthreshold region. In our gate circuit, we operate all MOSFETs in a current range of 1–100 nA. This can be performed by setting bias voltages V_{dd} and V_{gg} for the gate to appropriate values. For this purpose, we designed a power supply circuit described in the next section.
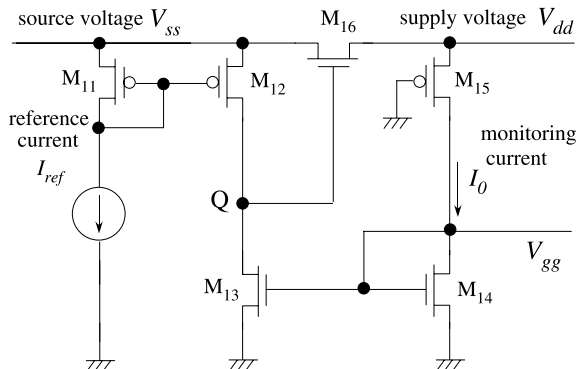
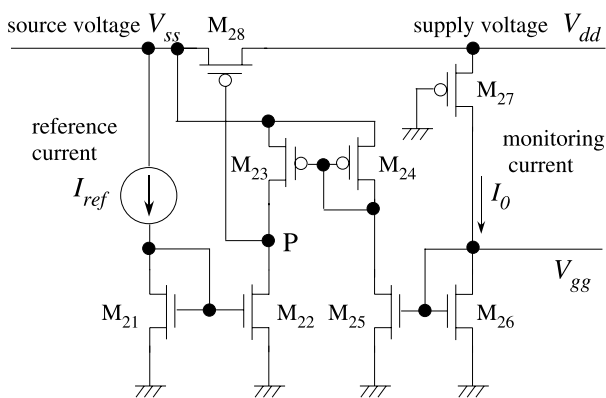**Fig. 5**   Power supply circuit for subthreshold logic gates.

Fig. 6   Modified power supply circuit for subthreshold logic gates.

3.2 Power Supply for the Gates

Two kinds of power supplies for our logic gates are shown in Figs. 5 and 6. Both convert an external source voltage V_{ss} to bias voltages V_{dd} and V_{gg} such that a current I_0 in monitoring transistors (M_{14}-M_{15} in Fig. 5 and M_{26}-M_{27} in Fig. 6) is equal to a given reference current I_{ref}. Voltages V_{dd} and V_{gg} are used as biases for the gates. The gate width of the monitoring transistors (M_{14}, M_{15}, M_{26}, and M_{27}) is set equal to that of the input transistors (M_1-M_3 in Fig. 3) in the gate. By setting I_{ref} to 1–100 nA, we can ensure the subthreshold operation of each MOSFET in the gate.

The circuit in Fig. 5 operates as follows. Reference current I_{ref} is injected to gate node Q of regulating transistor M_{16} through current mirror M_{11}-M_{12}, and monitoring current I_0 is drained from node Q through current mirror M_{13}-M_{14}. If $I_0 < I_{ref}$, the circuit performs a negative feedback operation to increase I_0; that is, $I_0 < I_{ref} \rightarrow$ node voltage Q increases $\rightarrow$ on-resistance in M_{16} decreases $\rightarrow$ supply voltage V_{dd} increases $\rightarrow$ monitoring current I_0 increases $\rightarrow I_0$ is equalized to I_{ref}. And if $I_0 > I_{ref}$, the circuit operates in a similar manner to equalize I_0 to I_{ref}. This circuit is stable and has no possibility of oscillation. However, it needs a large external source voltage V_{ss} because the voltage of node Q has to be larger than V_{dd} by the threshold voltage of M_{16}. The circuit cannot operate if external source voltage
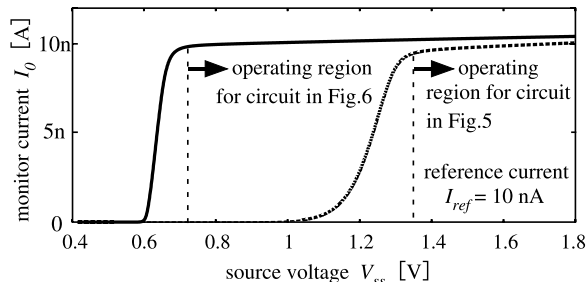

Fig. 7   Output voltage of power supply circuits as a function of external supply voltage.

V_{ss} is smaller than the sum of V_{dd} and the threshold voltage of M_{16}. For instance, with nMOS and pMOS transistors we used, external source voltage V_{ss} should be larger than 1.3 V as shown Fig. 7. Therefore, this circuit is unsuitable for the use of a manganese dry cell with a nominal voltage of 1.5 V.

This problem can be solved using a pMOS transistor as a regulating transistor. Figure 6 shows the modified circuit with the regulating transistor M_{28}. The operation is similar to that of the circuit in Fig. 5. The modified circuit can operate on condition that external source voltage V_{ss} is larger than the threshold voltage of M_{28}. The lower limit of external source voltage V_{ss} can be reduced to 0.7 V, as shown in Fig. 7. This circuit has the possibility of oscillation, so a compensation capacitance (1 pF) was connected for safety between the gate and the drain of M_{28}. We used this power supply circuit in the following sections.

3.3 Operation of the Gate

We simulated the operation of our gates, taking a 3-input majority gate ($k = 3/2$) shown in Fig. 3. We used the power supply circuit shown in Fig. 5. The transistor size was set to $W/L = 1\,\mu\text{m}/0.35\,\mu\text{m}$ for all transistors except for M_4 in the threshold-logic subcircuit (Fig. 3) and M_{28} in the power supply circuit (Fig. 6). The size of M_4 was set to $1.5\,\mu\text{m}/0.35\,\mu\text{m}$ because the gate width of M_4 was given by $(n-k) \times 1\,\mu\text{m}$, where n is the number of inputs ($n = 3$) and k is the threshold value ($k = 1.5$). The size of power M_{28} in the power supply circuit was set to $W/L = 80\,\mu\text{m}/0.35\,\mu\text{m}$. The external voltage V_{ss} was set to 1.5 V in the power supply circuit. Reference current I_{ref} was set to 10 nA, so the power supply circuit produced bias voltages V_{dd} and V_{gg} such that monitoring current I_0 was adjusted to be 10 nA. The values of V_{dd} and V_{gg} were 610 mV and 390 mV.

The result of simulation is shown in Fig. 8. In simulation, we increased the number of 1-inputs (inputs of which voltage is V_{dd}) with time. First, the three inputs for the gate was 000, then changed to 001 at time = 10 μs, to 011 at 20 μs, and to 111 at 30 μs. When two inputs rose to V_{dd} (logic 1), the voltage of the sum line changes from high to low, and the output inverter produces an output V_{dd} (logic 1). The circuit shows a majority logic operation. The current in the gate was maximum and 28 nA for an input of 001. For this input, the power consumption was maximum and
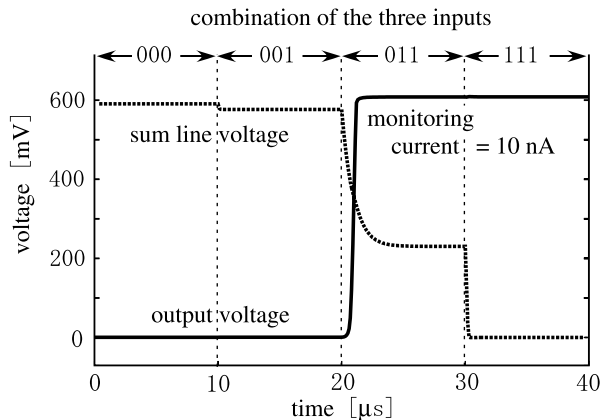
Fig. 8 Simulated results for sum-line voltage and output voltage in the majority gate.

Fig. 9 Schematics of (a) Full adder consisting of majority gates and inverters, (b) 8-bit addition, (c) ripple-carry adder, and (d) carry-look-ahead circuit.

17 nW. This value is smaller than other threshold-logic devices. For example, on the neuron MOSFET(νMOS) gate — a typical example of existing threshold-logic devices — the power consumption has been reported several hundreds of microwatts [5], [6].

If two or three inputs are 1, the voltage of the sum line should be 0 because current drained from the sum line is larger than injected current. In practice, however, the voltage of sum line was about 200 mV for an input of 011. This is so because the injected current through M_1, M_2, or M_3 and the drained current through M_4 in the gate were balanced at this voltage. However, because the voltage of sum line for input 011 is always lower than the inverting threshold voltage of the output inverter, the output inverter produces an output 1 correctly.

4. Adders Consisting of Threshold Logic Gates

Using the gate circuits, we designed a 8-bit ripple carry (RC) adder and a 8-bit carry-look-ahead (CLA) adder and simulated their operations.

Figure 9 (a) shows the full adder consisting of majority gates and inverters. Sum output S_i should be 1 when the number of 1-inputs in three inputs X_i, Y_i, and C_{i-1} is 1 or 3 (odd parity). Carry output C_i should be 1 when the number of 1-inputs is 2 or 3 (majority decision). These operations can be performed using 3 majority gates and 2 inverters. Figure 9(b) shows the operation of an 8-bit adder. Figure 9(c) shows the circuit of an 8-bit RC adder and Fig. 9(d) shows a carry-look-ahead circuit for the 8-bit CLA adder.

We confirmed the circuit operation by computer simulation and calculated the addition time of the RC and the CLA adders. Monitoring current I_0 and external voltage V_{ss} in the power supply circuit were set to 10 nA and 1.5 V. The number of gates that a signal has to passes from the least-significant-bit inputs (X_0Y_0) to the most-significant-bit output is 9 in the RC adder and 5 in the CLA adder. The addition time was the time to perform a calculation of 11111111 + 00000001 = 100000000. Figure 10 shows the waveforms for the voltage of each signal bit. The upper figure shows
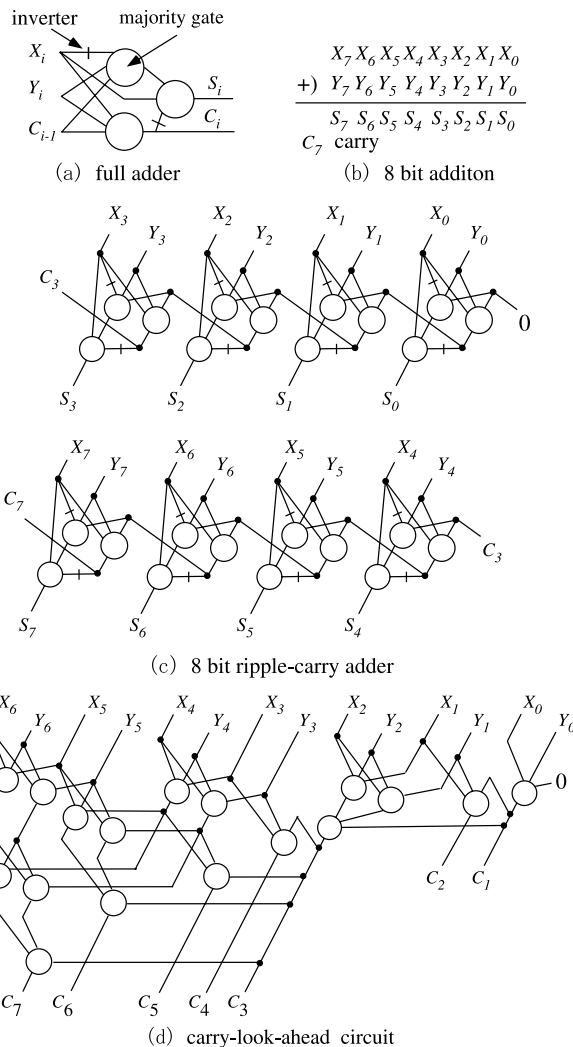
the voltages of input bits; all input bits were initially 0 and, at time = 0, nine bits were raised to 1 (= V_{dd}) and seven bits were kept 0. The middle figure depicts the voltages of output bits (sum bits and carry bits) of the RC adder. The bottom figure depicts the output bits of the CLA adder. The addition time was determined by the delay of the most significant bit S_7 of the sum output. The addition time of the RC adder was 5.1 μs (Fig. 10(a)), and that of the CLA adder was 3.4 μs (Fig. 10(b)).

5. Majority-Black Circuit Consisting of Threshold Logic Gates

As a promising application of our threshold logic gate, we designed cellular-automaton cells that perform morphological operations for picture processing. The following shows part of the result, taking the *majority-black* operation as an example. The majority-black operation is a morphological picture processing for binary images. It is useful for filling

small holes and eliminating small projections in objects and, therefore, can be used for noise elimination (Fig. 11(a)). The majority-black operation is a processing for a 3×3 pixel window, and its operation is as follows; set the center pixel to black if five or more pixels in the 3×3 window are black; otherwise set the center pixel to white (Figs. 11(b) and 11(c)). In picture processing, the majority-black operation is performed in all pixels on a picture synchronously with a clock.

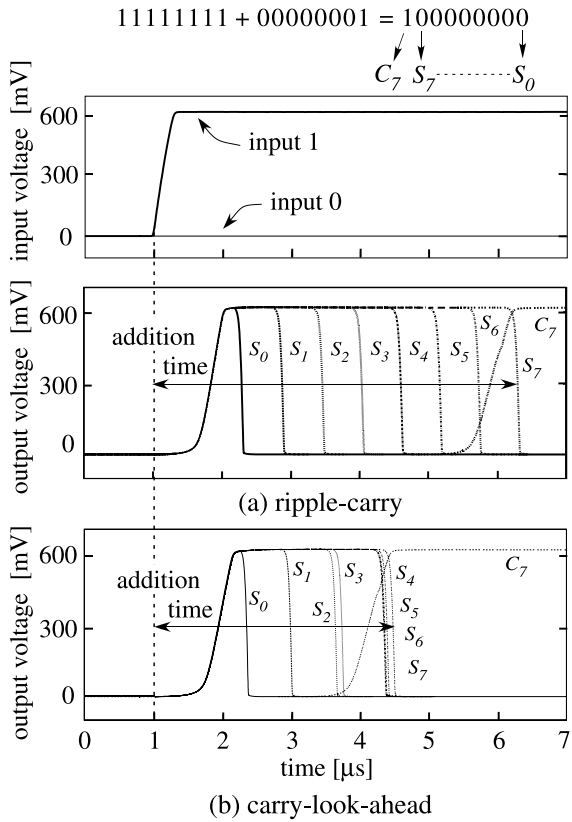The cell function of majority-black operation can be performed using a 9-input majority gate circuit shown in

$$11111111 + 00000001 = 100000000$$

Fig. 10 Operations of 8-bit adders. Simulated waveforms of input, output of RC adder, and output of CLA adder.

Fig. 12. Each input corresponds to the state of each pixel in the 3×3 window; we define that the input is 1 (voltage V_{dd}) if the pixel is black and the input is 0 if the pixel is white. The output of the circuit corresponds to the subsequent state of the center pixel; the subsequent state is black for a 1-output and white for a 0 output. If the number of 1-inputs for M_{31}-M_{39} is higher than the threshold (= 4.5), the net current injected to the sum line is negative. The output of the inverter rises to V_{dd} (logic 1). If the number of 1-inputs is lower than the threshold, the output falls to 0 (logic 0). The width of M_{40} is set to $4.5 \times 1\,\mu$m because the gate width of M_{40} is given by $(n - k) \times 1\,\mu$m, where n is the number of inputs ($n = 9$) and k is the threshold value ($k = 4.5$).

We simulated the operation of the majority-black circuit. The result is shown in Fig. 13. The reference current was set to $I_{ref} = 10$ nA. The external voltage V_{ss} was set to 1.5 V, and the power supply circuit produced voltages V_{dd} = 610 mV and V_{gg} = 390 mV. In simulation, we increased the number of 1-inputs with time. First, the nine inputs for the gate was 000000000, then changed to 000000001, 000000011, and 111111111. When five inputs rose to 1, the voltage of sum line fell and the inverter output changed from 0 to 1. The circuit performed a majority black operation successfully. The maximum current and power con-
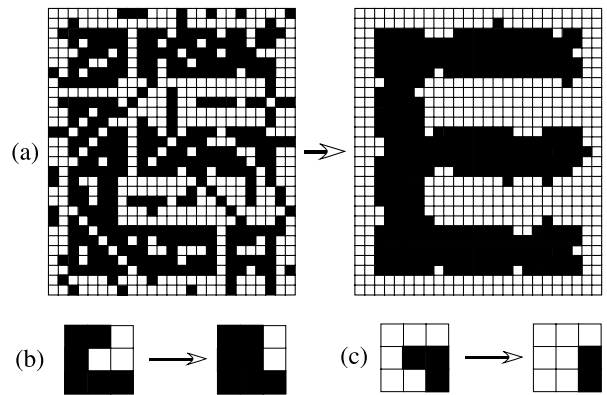

Fig. 11 Example of majority-black operation: (a) noise removal, (b) change of center cell from white to black, and (c) change of center cell from black to white.
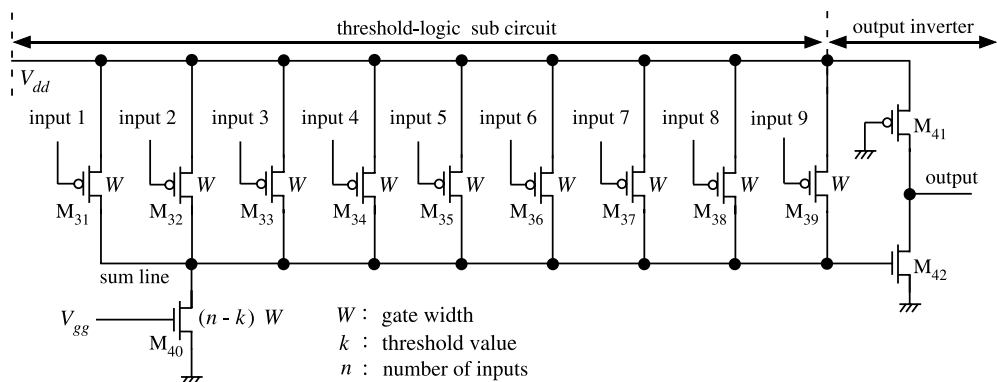

Fig. 12 Majority-black circuit consisting of threshold-logic gate.
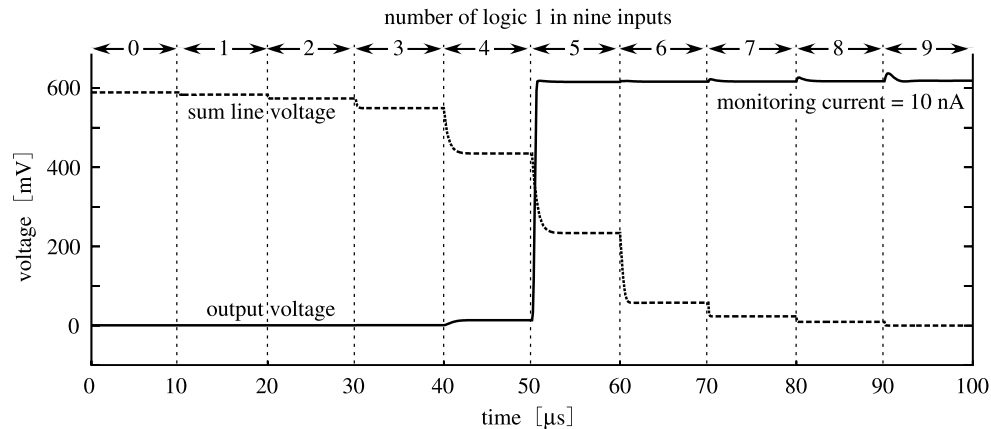
**Fig. 13**   Simulation results of the sum-line voltage and output voltage in majority black circuit.

sumption was 63 nA and 38 nW for an input of 000000000. Functional image sensors can be constructed by combining a number of the majority-black circuits with photosensors and signal-transferring circuits.

6. Conclusion

We proposed a threshold-logic gate consisting of subthreshold MOSFETs circuits. The circuit can be constructed with simple circuit configuration and low power dissipation, and can be used for elementary cell circuits for large-scale parallel signal processing such as cellular-automaton and neural-network applications. As example subsystems, we designed adders and majority-black operation cells by using the gates. Using our threshold-logic gate will enable us to constract low-power, functional processing LSIs.

References

[1] S. Muroga, Threshold logic and its applications, Wiley Interscience, 1971.

[2] A. Wang, B.H. Calhoun, and A.P. Chandrakasan, Sub-threshold Design for Ultra Low-Power Systems, Springer, 2006.

[3] T. Hirose, T. Asai, and Y. Amemiya, "Power-supply circuits for ultralow-power subthreshold MOS-LSIs," IEICE Electronics Express, vol.3, no.22, pp.464–468, 2006.

[4] T. Hirose, T. Matsuoka, K. Taniguchi, T. Asai, and Y. Amemiya, "Ultralow-power current reference circuit with low temperature dependence," IEICE Trans. Electron., vol.E88-C, no.6, pp.1142–1147, June 2005.

[5] M. Fukuhara and M. Yoshida, "Power consumption of a hamming distance search CAM using neuron MOS transistors," ISCAS 2006, pp.4345–4348, 2006.

[6] K. Kotani, T. Shibata, M. Imai, and T. Ohmi, "Clock-controlled neuron-MOS logic gates," IEEE Trans. Circuits Syst. II, Analog Digit. Signal Process., vol.45, no.4, pp.518–522, 1998.
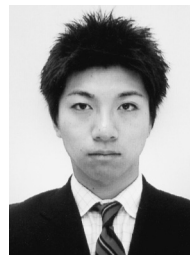
Taichi Ogawa   received the B.S. degree in electrical engineering from Hokkaido University, Sapporo, Japan, in 2007. He is currently working toward the M.E., degree in the electrical engineering at Hokkaido University, Sapporo, Japan. His current research interests are in low-power analog CMOS circuits.
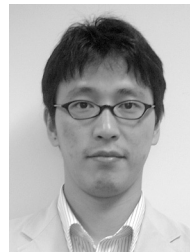
Tetsuya Hirose   received the B.S., M.S. and Ph.D. degrees from Osaka University, Osaka, Japan, in 2000, 2002, and 2005, respectively. From 2005–2008, he was a Research Associate at the Department of Electrical Engineering, Hokkaido University. Since April 2008, he has been a Lecturer at the Department of Electrical and Electronics Engineering, Kobe University, Kobe, Japan. His current research interests are in the field of low-power analog/digital integrated circuits design and subthreshold MOSFET functional LSIs for intelligent sensors. Dr. Hirose is a member of the Japan Society of Applied Physics, and the IEEE.

Tetsuya Asai   received the B.S., and M.S. degrees in electrical engineering from Tokai University, Kanagawa, Japan, in 1993 and 1996 respectively, and the Ph.D. in electrical and electronic engineering from Toyohashi University of Technology, Aichi, Japan, in 1999. He is now Associate Professor in the Graduate School of Information Science and Technology, Hokkaido University, Sapporo, Japan. His current research interests include nonlinear analog processing in neural networks and reaction-diffusion systems as well as design and applications of neuromorphic VLSIs. Dr. Asai is a member of the IEEE.
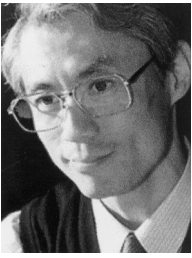
Yoshihito Amemiya received the B.E., M.E., and Dr. Engineering degrees from the Tokyo Institute of Technology, Tokyo, Japan, in 1970, 1972, and 1975. He joined NTT Musashino Laboratories in 1975, where he worked on the development of silicon process technologies for high-speed logic LSIs. From 1983 to 1993, he was with NTT Atsugi Laboratories and developed bipolar and CMOS circuits for Boolean logic LSIs, neural network LSIs, and cellular automaton LSIs. Since 1993, he has been a Professor with the Department of Electrical Engineering, Hokkaido University, Sapporo. His research interests are in the fields of silicon LSI circuits, signal processing devices based on nonlinear analog computation, logic systems consisting of single-electron circuits, and information-processing devices making use of quantum nanostructures.